

**AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

**LISTING OF CLAIMS:**

- Claims 1-7. (canceled).
8. (new): A sealing material comprising a fluorine-containing elastomer composition comprising a fluorine-containing elastomer and a crystalline carbon allotrope having an average primary particle size of at most 0.1  $\mu\text{m}$ .
9. (new): The sealing material of Claim 8, wherein the crystalline carbon allotrope having an average primary particle size of at most 0.1  $\mu\text{m}$  is diamond.
10. (new): The sealing material of Claim 8, wherein the fluorine-containing elastomer is a perfluoroelastomer.
11. (new): The sealing material for a semiconductor manufacturing equipment of Claim 8.
12. (new): A fluorine-containing elastomer composition comprising a fluorine-containing elastomer and a diamond having an average primary particle size of at most 0.1  $\mu\text{m}$ .
13. (new): The fluorine-containing elastomer composition of Claim 12, wherein the fluorine-containing elastomer is a perfluoroelastomer.
14. (new): The fluorine-containing elastomer composition for a semiconductor manufacturing equipment of Claim 12.

15. (new): A filler for a sealing material in a semiconductor manufacturing equipment comprising a crystalline carbon allotrope having an average primary particle size of at most 0.1  $\mu\text{m}$ .